



# Product Change Notification

## 112899 - 00

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# Product Change Notification

**Change Notification #:** 112899 - 00  
**Change Title:** Intel® Storage Server System JBOD2224S2DP  
PCN 112899-00, Product Design, Label  
Update Power Distribute Board, SAS  
Expander and Regulatory Label  
**Date of Publication:** February 25, 2014

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	Mar 12, 2014
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*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

## Description of Change to the Customer:

Intel has implemented the following changes on the Intel® Storage Server System JBOD2224S2DP:

1. Change the I<sup>2</sup>C address of the EEPROM on the PDB (Power Distribute Board) from 0xAE to 0xAC to avoid I<sup>2</sup>C address conflict with the front panel.
2. Update the SAS expander FW from version v0.13.0.6 to v0.13.0.8, and MFG version from 1.03 to 1.04, so that the SAS expander can read the system Enclosure ID from the EEPROM on the PDB with the updated I<sup>2</sup>C address.
3. Remove the Argentina safety logo (see Figure 1) from the regulatory labels on the system chassis and the side of the shipping carton to comply with Argentina regulation requests.



Figure 1: The removed Argentina safety logo

Please contact your local Intel Sales Office or Distribution if you require more information.

**Customer Impact of Change and Recommended Action:**

Intel recommends that customers validate the function and feature changes after receiving the systems.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Post Change TA
JBOD2224S2DP	927045	G79980-002	G79980-003

**PCN Revision History:****Date of Revision:**

February 25, 2014

**Revision Number:**

00

**Reason:**

Originally Published PCN